# 2K/4K/8K bit Serial I<sup>2</sup>C bus EEPROM

#### DESCRIPTION

The CW24C02A/04A/08A provides 2048/4096/8192 bits of serial electrically erasable and programmable read-only memory (EEPROM), organized as 256/512/1024 words of 8 bits each. The device is optimized for use in many industrial and commercial applications where low-power low-voltage operation are essential.

The CW24C02A/04A/08A is accessed via a two-wire serial interface and is available in 1.7V (1.7V to 5.5V) version.

#### **FEATURES**

- Wide Voltage Operation  $V_{CC} = 1.7V$  to 5.5V
- Operating Ambient Temperature: -40°C to +85°C
- Internally Organized:
  - CW24C02A, 256 x 8 (2K bits)
  - CW24C04A, 512 x 8 (4K bits)
  - CW24C08A, 1024 x 8 (8K bits)
- Two-wire Serial Interface
- Schmitt Trigger, Filtered Inputs for Noise Suppression
- Bidirectional Data Transfer Protocol
- 1MHz (5V, 3V), 400 KHz (1.7V) Compatibility
- 8-byte Page (CW24C02A), 16-byte Page (CW24C04A/08A) Write Modes
- Partial Page Writes Allowed
- Self-timed Write Cycle (4 ms max)
- High-reliability
  - Endurance: 1 Million Write Cycles
  - Data Retention: 100 Years
- PDIP8/SOP8/TSSOP8/UDFN8/CPC8/SOT23-5/ TSOT23-5/MSOP8 Packages

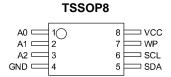
#### APPLICATIONS

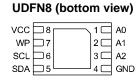
- Intelligent Instrument
- Household Appliance
- **Automotive Electronics**
- Communications
- Consumer electronic

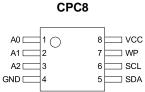
#### PIN CONFIGURATION

#### PDIP8 8 | vcc A0 ☐ 7 WP A1 ∏2 6 ∏ SCL A2 ∏3 5 SDA GND ∏4

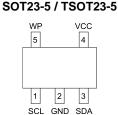
#### SOP8 8 🗀 vcc A1 □ □ WP A2 [ ⊐ SCL □ SDA GND □

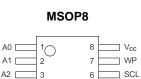












GND I

4



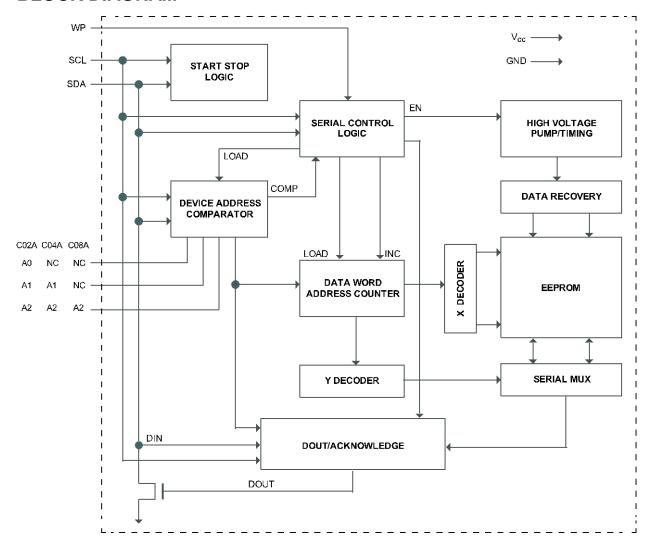
□ SDA

# **ORDERING INFORMATION**

Temperature Range	Package		Orderable Device	Package Qty.
		PDIP8	CW24CXXXP	50 Units/Tube
		SOP8	CW24CXXXD	100 Units/Tube
		30F6	CW24CXXXDR	3000 Units/R&T
		TSSOP8	CW24CXXXT	100 Units/Tube
40°C 105°C	°C ~ +85°C Pb-Free	133076	CW24CXXXTR	4000 Units/R&T
-40 C ~ +65 C		UDFN8	CW24CXXXUR	4000 Units/R&T
		CPC8	CW24CXXXCR	15K Units/R&T
		SOT23-5	CW24CXXXS5R	3000 Units/R&T
		TSOT23-5	CW24CXXXTS5R	3000 Units/R&T
		MSOP8	CW24CXXXM	4000 Units/R&T

XXX= 02A/04A/08A

## **BLOCK DIAGRAM**





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# **ABSOLUTE MAXIMUM RATINGS**

(Maximum Ratings are those values beyond which damage to the device may occur.)

Parameter	Symbol	Value	Unit
DC Supply Voltage	V <sub>CC</sub>	-0.3 ~ + 6.5	V
DC Input Voltage	V <sub>IN</sub>	GND - 0.3 ~ V <sub>CC</sub> + 0.3	V
DC Output Voltage	V <sub>OUT</sub>	GND - 0.3 ~ V <sub>CC</sub> + 0.3	V
Operating Ambient Temperature	T <sub>a</sub>	-55 ~ +125	°C
Storage Temperature	T <sub>STG</sub>	-65 ~ +150	°C

#### RECOMMENDED OPERATING CONDITIONS

(Functional operation should be restricted to the Recommended Operating Conditions.)

Parameter	Symbol	Min	Max	Unit
DC Supply Voltage	V <sub>cc</sub>	1.7	5.5	V
Operating Temperature	T <sub>A</sub>	-40	+85	°C

#### **CAPACITANCE**

(Applicable over recommended operating range from  $T_A = 25$ °C, f = 1.0 MHz,  $V_{CC} = +1.7$ V)

Parameter	Symbol	Test Conditions	Min	Max	Unit
Input/Output Capacitance (SDA)	C <sub>I/O</sub>	$V_{I/O} = 0V$	- 1	8	pF
Input Capacitance (A0, A1, A2, SCL)	C <sub>IN</sub>	$V_{IN} = 0V$	-	6	рF

# DC ELECTRICAL CHARACTERISTICS

(Applicable over recommended operating range from:  $T_A = -40$ °C to +85°C,  $V_{CC} = +1.7$ V to +5.5V unless otherwise noted)

Parameter	Symbol	Test	t Conditions	Min	Тур	Max	Unit
Supply Voltage	V <sub>CC</sub>	-		1.7	-	5.5	V
Cupply Current	ı	\/ 5\/	Read at 400kHz	-	0.4	2.0	mA
Supply Current	I <sub>CC</sub>	$V_{CC} = 5V$	Write at 400kHz	-	1.5	2.0	mA
		$V_{IN} = V_{CC}$	/ GND, V <sub>CC</sub> =1.7V	-	0.6	1.0	μA
Standby Current	I <sub>SB</sub>	$V_{IN} = V_{CC}$	/ GND, V <sub>CC</sub> =2.5V		1.0	2.0	μA
		$V_{IN} = V_{CC} / GND, V_{CC} = 5.5V$		-	1.5	2.0	μA
Input Leakage	ı	V - V	or CND		0.10	2.0	
Current	ILI	$V_{IN} = V_{CC}$	-	0.10	2.0	μA	
Output Leakage		\/ \/	or CND		0.05	2.0	
Current	I <sub>LO</sub>	$V_{OUT} = V_{C}$	COLGIND	-	0.05	2.0	μA
Input Love Love	W	V <sub>CC</sub> = 1.8\	/ to 5.5V	-0.3	-	V <sub>CC</sub> x0.3	V
Input Low Level	$V_{IL}$	V <sub>CC</sub> = 1.7V		-0.3	-	V <sub>CC</sub> x0.2	V
Input High Level	V <sub>IH</sub>	V <sub>CC</sub> = 1.7\	/ to 5.5V	V <sub>CC</sub> x0.7	-	V <sub>CC</sub> +0.3	V



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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
	$V_{OL3}$	$V_{CC} = 5.0V, I_{OL} = 3.0 \text{ mA}$	-		0.4	V
Output Low Level	$V_{OL2}$	$V_{CC} = 3.0V, I_{OL} = 2.1 \text{ mA}$	-	-	0.4	V
	V <sub>OL1</sub>	$V_{CC} = 1.7V, I_{OL} = 0.15 \text{ mA}$	-	-	0.2	V

## **AC ELECTRICAL CHARACTERISTICS**

(Applicable over recommended operating range from  $T_A = -40$ °C to +85°C,  $V_{CC} = +1.7$ V to +5.5V,  $C_L = 1$  TTL Gate and 100 pF unless otherwise noted)

Parameter	Symbol	<b>Test Conditions</b>	Min	Тур	Max	Unit	
Clock Fragues av SCI	ſ	1.7V <v<sub>CC&lt;2.5V</v<sub>	-	-	400		
Clock Frequency, SCL	f <sub>SCL</sub>	2.5V <v<sub>CC&lt;5.5V</v<sub>	-	-	1000	kHz	
Clock Dules Width Low	4	1.7V <v<sub>CC&lt;2.5V</v<sub>	1.2	-	-		
Clock Pulse Width Low	t <sub>LOW</sub>	2.5V <v<sub>CC&lt;5.5V</v<sub>	0.6	-	-	μs	
Clock Dulce Width High	4	1.7V <v<sub>CC&lt;2.5V</v<sub>	0.6	-	-		
Clock Pulse Width High	t <sub>HIGH</sub>	2.5V <v<sub>CC&lt;5.5V</v<sub>	0.4	-	-	μs	
Noise Suppression Time	4	1.7V <v<sub>CC&lt;2.5V</v<sub>	-	-	50	20	
Noise Suppression Time	t <sub>I</sub>	2.5V <v<sub>CC&lt;5.5V</v<sub>	-	-	50	ns	
Clock Low to Data Out Valid	4	1.7V <v<sub>CC&lt;2.5V</v<sub>	0.1	-	0.9		
Clock Low to Data Out Valid	t <sub>AA</sub>	2.5V <v<sub>CC&lt;5.5V</v<sub>	0.05	-	0.9	μs	
Time the bus must be free		1.7V <v<sub>CC&lt;2.5V</v<sub>	1.2	-	-		
before a new transmission can start	t <sub>BUF</sub>	2.5V <v<sub>CC&lt;5.5V</v<sub>	0.5	-	-	μs	
Ctart Hold Times	1	1.7V <v<sub>CC&lt;2.5V</v<sub>	0.6	-	-		
Start Hold Time	t <sub>HD.STA</sub>	2.5V <v<sub>CC&lt;5.5V</v<sub>	0.25	-	-	μs	
Start Satur Time	4	1.7V <v<sub>CC&lt;2.5V</v<sub>	0.6	-	-		
Start Setup Time	t <sub>SU.STA</sub>	2.5V <v<sub>CC&lt;5.5V</v<sub>	0.25	-	-	μs	
Data In Hold Time	t <sub>HD.DAT</sub>	1.7V <v<sub>CC&lt;5.5V</v<sub>	0	-	-	μs	
Data In Setup Time	t <sub>SU.DAT</sub>	1.7V <v<sub>CC&lt;5.5V</v<sub>	100	-	-	ns	
Inputs Rise Time	t <sub>R</sub>	-	-	-	300	ns	
Inputs Fall Time	t <sub>F</sub>	-	-	-	300	ns	
Stan Satur Time	4	1.7V <v<sub>CC&lt;2.5V</v<sub>	0.6	-	-		
Stop Setup Time	t <sub>su.sto</sub>	2.5V <v<sub>CC&lt;5.5V</v<sub>	0.25	-	-	μs	
Data Out Hold Time	t <sub>DH</sub>	-	50	-	-	ns	
Write Cycle Time	t <sub>WR</sub>		-	3.3	4	ms	
5.0V,25°C,Byte Mode	Endurance	-	1M	-	-	Write Cycles	

#### Note:

1. This parameter is characterized and is not 100% tested.

2. AC measurement condition:

Input pulse voltages: 0.3  $V_{CC}$  to 0.7  $V_{CC}$ ;

Input rise and fall time: 50 ns



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Input and output timing reference voltages: 0.5  $V_{\text{CC}}$ 

The value of  $R_{\text{L}}$  should be concerned according to the actual loading on the user's system.

 $R_L$   $\,$  (connects to  $V_{CC}$ ): 1.3KQ  $\,$   $(2.5V,\!5V)$  , 10KQ  $\,$  (1.7V)

# **PIN DESCRIPTION**

N	lo.	Nama	Function Description		
5 PIN	8 PIN	Name	Function Description		
-	1	A0 / NC	Address input. The A2, A1 and A0 pins are device		
-	2	A1 / NC	address inputs that are hard wired for the CW24C02A.		
-	3	A2	Eight CW24C02A devices may be addressed on a sing bus system (device addressing is discussed in defunder the Device Addressing section).  The CW24C04A uses the A2 and A1 inputs for hard waddressing and a total of four CW24C04A devices may be addressed on a single bus system. The A0 pin is a connect and can be connected to ground.  The CW24C08A only uses the A2 input for hardwaddressing and a total of two CW24C08A devices may be addressed on a single bus system. The A0 and a pins are no connects and can be connected to ground.		
2	4	GND	Circuit ground pin.		
3	5	SDA	Serial address and data I/O. This pin is open-drain driven and may be wire-ORed with any number of other open-drain or open- collector devices.		
1	6	SCL	Serial clock input. The SCL input is used to positive edge clock data into each EEPROM device and negative edge clock data out of each device.		
5	7	WP	Write protect. The WP pin that provides hardware data protection. The WP pin allows normal read/write operations when connected to ground (GND). When the WP pin is connected to $V_{CC}$ , the write protection feature is enabled and read only.		
4	8	VCC	Positive supply voltage.		

## **MEMORY ORGANIZATION**

Device	Total bits	Total pages	Bytes per page	Word address
CW24C02A	2K	32	8	8-bit
CW24C04A	4K	32	16	9-bit
CW24C08A	8K	64	16	10-bit



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#### **DEVICE OPERATION**

#### Clock and data transitions

The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods (see Figure 1). Data changes during SCL high periods will indicate a start or stop condition as defined below.

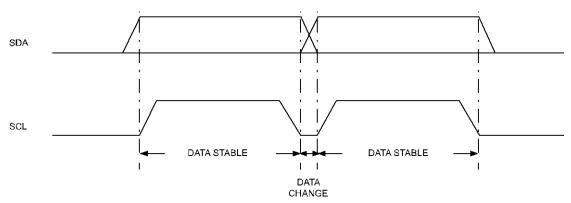


Figure 1. Data Validity

#### **Start Conditions**

A high-to-low transition of SDA with SCL high is a start condition which must precede any other Command. (see Figure 2)

#### **Stop Conditions**

A low-to-high transition of SDA with SCL high is a stop condition. After a read sequence, the stop command will place the EEPROM in a standby power mode. (see Figure 2)

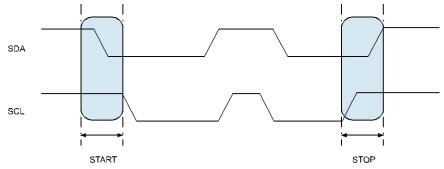


Figure 2. Start and Stop Definition

#### **Acknowledge**

All addresses and data words are serially transmitted to and from the EEPROM in 8-bit words. The EEPROM sends a "0" to acknowledge that it has received each word. This happens during the ninth clock cycle.

#### **Standby Mode**

The CW24C02A/04A/08A features a low-power standby mode which is enabled: (1) upon power-up and (2) after the receipt of the STOP bit and the completion of any internal operations.



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#### **Memory Reset**

After an interruption in protocol, power loss or system reset, any two-wire part can be reset by following these steps:

- (1) Clock up to 9 cycles.
- (2) Look for SDA high in each cycle while SCL is high.
- (3) Create a start condition.

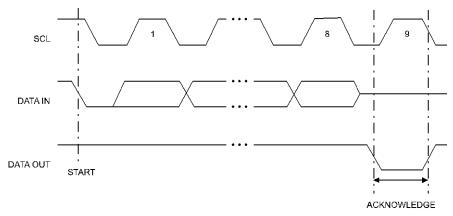


Figure 3. Output Acknowledge

#### **DEVICE ADDRESSING**

The CW24C02A/04A/08A devices all require an 8-bit device address word following a start condition to enable the chip for a read or write operation (see Figure 4)

The device address word consists of a mandatory "1", "0" sequence for the first four most significant bits as shown. This is common to all the Serial EEPROM devices.

The next 3 bits are the A2, A1 and A0 device address bits for the CW24C02A. These 3 bits must compare to their Corresponding hardwired input pins.

The CW24C04A only uses the A2 and A1 device address bits with the third bit being a memory page address bit. The two device address bits must compare to their corresponding hardwired input pins. The A0 pin is no connect.

The CW24C08A only uses the A2 device address bit with the next 2 bits being for memory page addressing. The A2 bit must compare to its corresponding hard-wired input pin. The A1 and A0 pins are no connect.

The eighth bit of the device address is the read/write operation select bit. A read operation is initiated if this bit is high and a write operation is initiated if this bit is low.

Upon a compare of the device address, the EEPROM will output a "0". If a compare is not made, the chip will return to a standby state.



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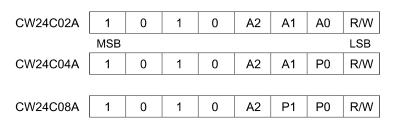


Figure 4. Device Address

#### WRITE OPERATIONS

#### **Byte Write**

A write operation requires an 8-bit data word address following the device address word and acknowledgment. Upon receipt of this address, the EEPROM will again respond with a "0" and then clock in the first 8-bit data word. Following receipt of the 8-bit data word, the EEPROM will output a "0" and the addressing device, such as a microcontroller, must terminate the write sequence with a stop condition. At this time the EEPROM enters an internally timed write cycle,  $t_{WR}$ , to the nonvolatile memory. All inputs are disabled during this write cycle and the EEPROM will not respond until the write is complete (see Figure 5).

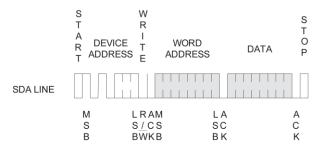


Figure 5. Byte Write

#### Page Write

The CW24C02A device is capable of an 8-byte page write, and the CW24C04A/08A devices are capable of 16-byte page writes.

A page write is initiated the same as a byte write, but the microcontroller does not send a stop condition after the first data word is clocked in. Instead, after the EEPROM acknowledges receipt of the first data word, the microcontroller can transmit up to 7 (CW24C02A) or 15 (CW24C04A/08A) more data words. The EEPROM will respond with a "0" after each data word received. The microcontroller must terminate the page write sequence with a stop condition (see Figure 6).

The data word address lower 3 (CW24C02A) or 4 (CW24C04A/08A) bits are internally incremented following the receipt of each data word. The higher data word address bits are not incremented, retaining the memory page row location. When the word address, internally generated, reaches the page boundary, the following byte is placed at the beginning of the same



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page. If more than 8 (CW24C02A) or 16 (CW24C04A/08A) data words are transmitted to the EEPROM, the data word address will "roll over" and previous data will be overwritten.

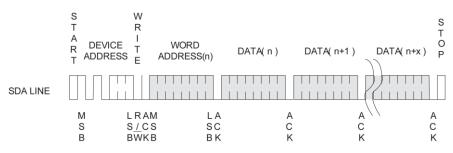


Figure 6. Page Write

#### **Acknowledge Polling**

Once the internally timed write cycle has started and the EEPROM inputs are disabled, acknowledge polling can be initiated. This involves sending a start condition followed by the device address word. The read/write bit is representative of the operation desired. Only if the internal write cycle has completed will the EEPROM respond with a "0", allowing the read or write sequence to continue.

#### READ OPERATIONS

Read operations are initiated the same way as write operations with the exception that the read/write select bit in the device address word is set to "1". There are three read operations: current address read, random address read and sequential read.

#### **Current Address Read**

The internal data word address counter maintains the last address accessed during the last read or write operation, incremented by one. This address stays valid between operations as long as the chip power is maintained. The address "roll over" during read is from the last byte of the last memory page to the first byte of the first page. The address "roll over" during write is from the last byte of the current page to the first byte of the same page.

Once the device address with the read/write select bit set to "1" is clocked in and acknowledged by the EEPROM, the current address data word is serially clocked out. The microcontroller does not respond with an input "0" but does generate a following stop condition (see Figure 7).

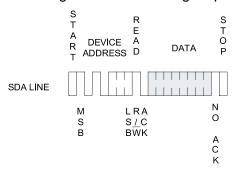


Figure 7. Current Address Read



#### Random Read

A random read requires a "dummy" byte write sequence to load in the data word address. Once the device address word and data word address are clocked in and acknowledged by the EEPROM, the microcontroller must generate another start condition. The microcontroller now initiates a current address read by sending a device address with the read/write select bit high. The EEPROM acknowledges the device address and serially clocks out the data word. The microcontroller does not respond with a "0" but does generate a following stop condition (see Figure 8).

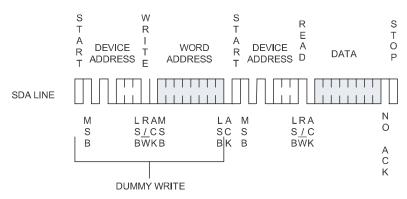


Figure 8. Random Read

#### **Sequential Read**

Sequential reads are initiated by either a current address read or a random address read. After the microcontroller receives a data word, it responds with an acknowledgement. As long as the EEPROM receives an acknowledgement, it will continue to increment the data word address and serially clock out sequential data words. When the memory address limit is reached, the data word address will "roll over" and the sequential read will continue. The sequential read operation is terminated when the microcontroller does not respond with a "0" but does generate a following stop condition (see Figure 9).

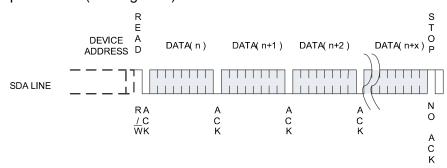


Figure 9. Sequential Read

# **BUS TIMING**

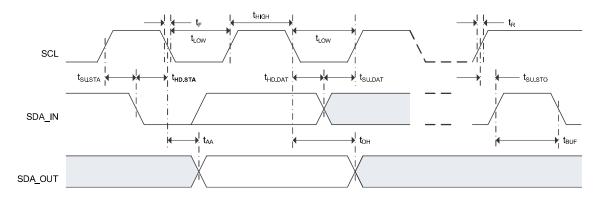
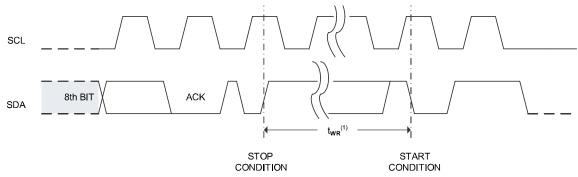


Figure 10. SCL: Serial Clock, SDA: Serial Data

# WRITE CYCLE TIMING

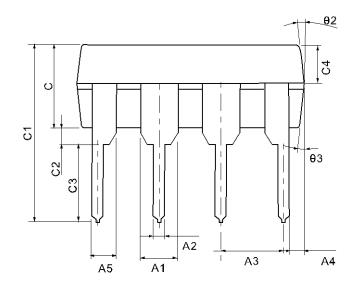


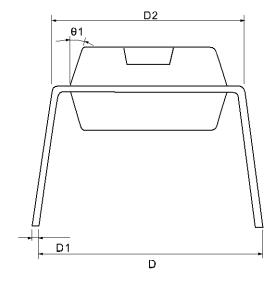
Notes: The write cycle time  $t_{WR}$  is the time from a valid stop condition of a write sequence to the end of the internal clear/write cycle.

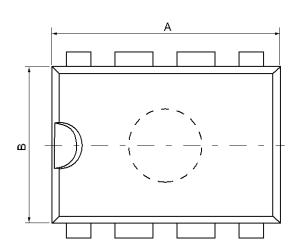
Figure 11. SCL: Serial Clock, SDA: Serial Data I/O

# **PHYSICAL DIMENSIONS**

# DIP8





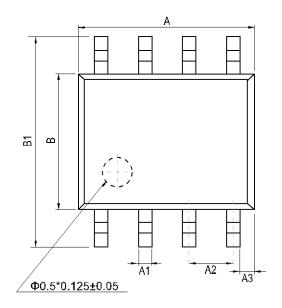


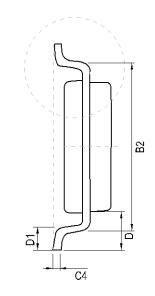
Symbol	Dimensio	on (mm)	Symbol	Dimensio	on (mm)
Symbol	Min	Max	Symbol	Min	Max
Α	9.00	9.20	C2	0.50 (	TYP)
A1	1.474	1.574	C3	3.20	3.40
A2	0.41	0.51	C4	1.47	1.57
А3	2.44	2.64	D	8.20	8.80
A4	0.51(	TYP)	D1	0.244	0.264
A5	0.99(	TYP)	D2	7.62	7.87
В	6.10	6.30	θ1	17° (TYP)	
С	3.20	3.40	θ2	10° (TYP)	
C1	7.10	7.30	θ3	8° (T	YP)

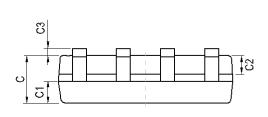


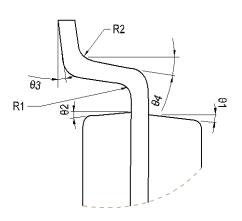
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## SOP8







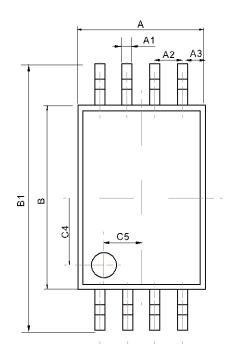


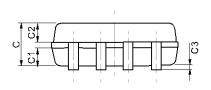
Symbol	Dimension (mm)		Symbol	Dimensio	on (mm)
Symbol	Min	Max	Symbol	Min	Max
Α	4.80	5.00	C3	0.05	0.20
A1	0.356	0.456	C4	0.203	0.233
A2	1.27(	TYP)	D	1.05(	TYP)
А3	0.345	(TYP)	D1	0.40	0.80
В	3.80	4.00	R1	0.20 (	TYP)
B1	5.80	6.20	R2	0.20 (	TYP)
B2	5.00 (	TYP)	θ1	17° (	TYP)
С	1.30	1.60	θ2	13° (TYP)	
C1	0.55	0.65	θ3	0° ~ 8° (TYP)	
C2	0.55	0.65	θ4	4° ~ 12° (TYP)	

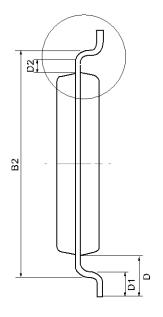


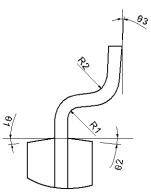
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# TSSOP8







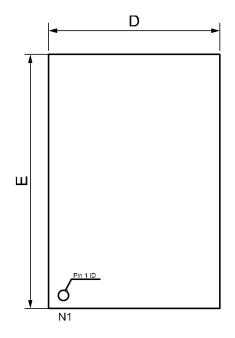


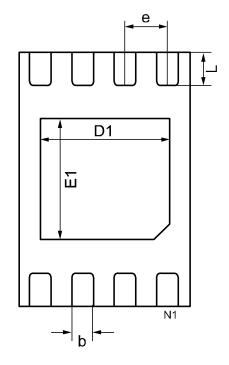
Cymbal	Dimensio	on (mm)	Symbol	Dimensio	n (mm)
Symbol	Min	Max	Symbol	Min	Max
А	2.90	3.10	C4	1.55	1.65
A1	0.20	0.30	C5	0.85	0.95
A2	0.60	0.70	D	1.00 (	TYP)
А3	0.41	0.42	D1	0.50	0.70
В	4.30	4.50	D2	0.19	0.29
B1	6.30	6.50	R1	0.15(	TYP)
B2	5.404	5.504	R2	0.15(	TYP)
С	0.95	1.05	θ1	12° (	TYP)
C1	0.415	0.465	θ2	12° (TYP)	
C2	0.39	0.49	θ3	0° ~ 7°	
C3	0.05	0.15	-		-



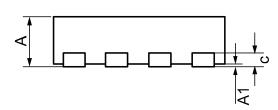
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# **UDFN8**



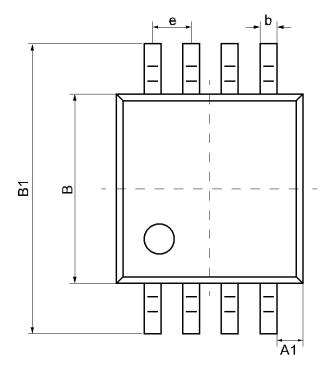


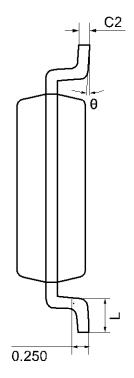
bottom view

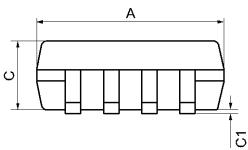


Symbol	Dimension (mm)			Cymbol	Dimension (mm)		
	Min	Тур.	Max	Symbol	Min	Тур.	Max
Α	0.50	0.55	0.60	е	0.50TYP		
A1	0.00	0.03	0.05	Е	2.95	3.00	3.05
b	0.20	0.25	0.30	E1	1.30	1.40	1.50
С	0.152REF			D1	1.40	1.50	1.60
D	1.95	2.00	2.05	L	0.35	0.40	0.45

# CPC8

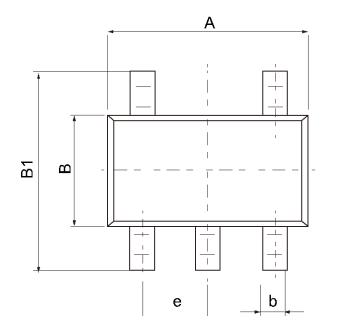


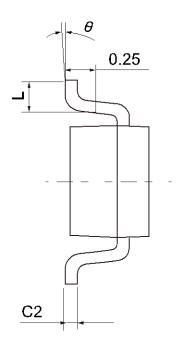


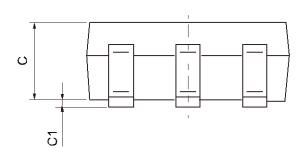


Symbol	Dimensio	n (mm)	Symbol	Dimension (mm)	
	Min	Max		Min	Max
А	2.50	2.70	С	0.85	1.05
A1	0.35	0.45	C1	0.00	0.15
е	0.53 (BSC)		C2	0.15	0.18
В	2.50	2.70	L	0.40	0.60
B1	3.85	4.15	θ	0°	8°
b	0.16	0.26	-	-	-

# SOT23-5

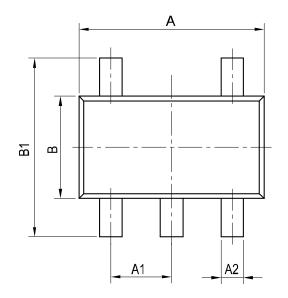


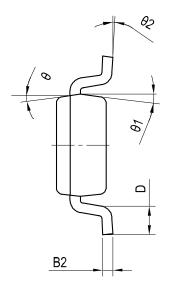


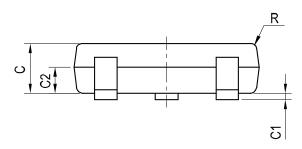


Symbol	Dimensio	n (mm)	Cymahal	Dimension (mm)	
	Min	Max	Symbol	Min	Max
А	2.82	3.02	С	1.05	1.15
е	0.95 (BSC)		C1	0.03	0.15
b	0.28	0.45	C2	0.12	0.23
В	1.50	1.70	L	0.35	0.55
B1	2.75	3.05	θ	0°	8°

# **TSOT23-5**

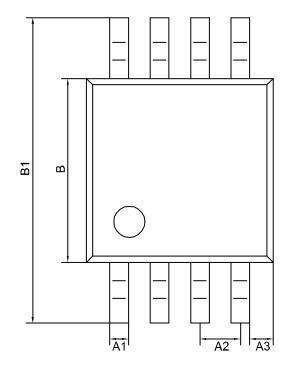


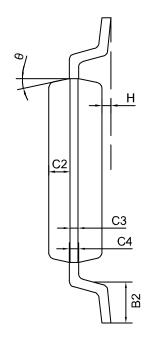


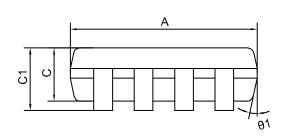


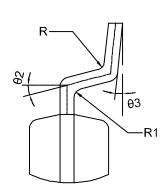
符号	Dimensio	n (mm)	符号	Dimension (mm)		
	Min	Max		Min	Max	
Α	2.820	3.020	C1	0.000	0.100	
A1	0.950 (BSC)		C2	0.378	0.438	
A2	0.350	0.500	D	0.300	0.600	
В	1.600	1.700	θ	9° TYP4		
B1	2.650	2.950	θ1	10° TYP4		
B2	0.080	0.200	θ2	0~8°		
С	0.700	0.800	-	-		

## MSOP8









符号	Dimensio	on (mm)	符号	Dimension (mm)		
	Min	Max		Min	Max	
Α	2.90	3.10	C3	0.152		
A1	0.28	0.35	C4	0.15	0.23	
A2	0.65	TYP	Н	0.00	0.09	
A3	0.375	5TYP	θ	12° TYP4		
В	2.90	3.10	θ1	12° TYP4		
B1	4.70	5.10	θ2	14° TYP		
B2	0.45	0.75	θ3	0° ~ 6°		
С	0.75	0.95	R	0.15TYP		
C1	-	1.10	R1	0.15TYP		
C2	0.328TYP		-	-		



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